

# **PRODUCT SPECIFICATIONS SHEET**

# CAT NO. PRODUCT NAME

10-114 Quik Stik 19-822

#### **DESCRIPTION:**

A two part unfilled epoxy adhesive designed for high speed bonding of metal, ceramics and most plastics. It cures to a tough semi-rigid material and is free flowing in viscosity. It gives a good resistance to water, salt spray, inorganic acids and bases and most organic solvents. It was especially formulated to a 1:1 mix ratio.

Cure is normally achieved at room temperature with-in 20 - 30 minutes with full cure in 24 hours. An elevated temperature cure schedule can be used to reach final properties quickly.

#### **TYPICAL PROPERTIES:**

All properties given are at 25C unless otherwise noted.

Color		Clear
Viscosity	Part A Part B Mixed	12,000 cps 18,000 cps 13,000 cps (est)
Specific Gravity	Part A Part B Mixed	1.17 1.15 1.16
Pot Life Mass		3 – 5 minutes 20 grams
Tensile Strength Lap Shear (AI/AI)		2200 psi
T-Peel Strength		3 – 5 pli
Temperature Range		-40 to 180F
Hardness Method		80 Shore-D

Linear Coefficient of Thermal Expansion (x 10 (6))/C

### **INSTRUCTIONS:**

- 1. Bring both components to room temperature prior to mixing. Mix 1 part of A to 1 part of B thoroughly.
- 2. Allow to cure undisturbed until product is fully gelled or tack-free to the touch.
- 3. Clean up uncured resin with suitable organic solvent such as MEK, Acetone or a Chlorinated Solvent.

## MIX RATIO:

1A:1B by weight of 1A:1B by volume.

#### SHELF LIFE:

12 months